



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts,Customers Priority,Honest Operation,and Considerate Service",our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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C 091 B Characteristics

General Characteristics	Standard	Characteristics									
Number of contacts		3	4	5	5 Stereo	6	7	7	8	12	14
View on termination side of male contact insert											
Contact arrangement	DIN EN 61076-2-106	03-a ✓	04-a ✓	05-a ✓	05-b ✓	06-a ✓	07-a ✓	07-b ✓	08-a ✓	12-a ✓	14-a ✓
Contact arrangement	IEC 60130-9 ¹⁾	✓	✓		✓	✓		✓	✓		
Electrical Characteristics											
Rated voltage	IEC 60664-1	300 V ≈			100 V ≈	300 V ≈			150 V ≈		
Rated voltage	UL 1977	250 V								60 V	
Rated impulse withstand voltage	IEC 60664-1	1500 V			1200 V	1500 V			1200 V		
Pollution degree	IEC 60664-1	1									
Installation category	IEC 60664-1	I									
Insulation group	IEC 60664-1	II, 400 ≤ CTI < 600									
Current rating	IEC 60512-5-2 UL 1977	5 A / + 40 °C / + 104 °F please refer also to current derating curves page 59								3 A / + 40 °C / + 104 °F	
Insulation resistance	IEC 60512-3-1	> 10 ¹⁰ Ω ²⁾									
Contact resistance	IEC 60512-2-1	< 5 m Ω									
Climatic Characteristics											
Climatic category	IEC 60668-1	40 / 100 / 56									
Temperature range	IEC 60668-1	- 40 °C ... + 100 °C / - 40 °F ... + 212 °F									
Mechanical Characteristics											
IP-degree	IEC 60529	IP 40									
Insertion and withdrawal forces	IEC 60512-13-2	25 N 90.oz	30 N 110.oz	35 N 125.oz	50 N 180.oz	55 N 200.oz	60 N 220.oz	50 N 180.oz			
Mechanical operation	IEC 60512-9-1	Silver ≥ 500 mating cycles Gold ≥ 1000 mating cycles									
Materials											
Housing material		die cast, nickel plated									
Dielectric material		thermoplastic									
Contact plating		silver plated / gold plated ³⁾									
Further Characteristics											
Termination technique		solder, crimp									
Wire gauge		solder: ≤ 0,5 mm ² / 20 AWG crimp: 2 - 6 pol (excluding 5S): 0,09 - 1,00 mm ² / 28 - 18 AWG crimp: 5S, 7, 7S and 8-pol.: 0,09 - 0,75 mm ² / 28 - 20 AWG								solder: ≤ 0,25 mm ² / 24 AWG crimp: 0,09-0,25 mm ² / 28 - 24 AWG	
Flammability		UL 94 V0									
Locking system		bayonet									

Caution: Do not connect or disconnect under load. Metal housing parts shall be securely incorporated to protected ground.

¹⁾ Edition 2000-05

²⁾ under operating conditions >10⁸ Ω

³⁾ Remark for gold plated contacts: In order to avoid brittle inter-metallic connections, gold-plated terminals have to be tin-plated in the solder area.

IEC 60 664 ≙ DIN VDE 0110; IEC 60 512-x ≙ DIN EN 60 512-x; IEC 60 130-9 ≙ DIN EN 60 130-9; IEC 61076-2-106 ≙ DIN EN 61076-2-106